

## Spread Spectrum Clock Generator

MB88154A is a clock generator for EMI (Electro Magnetic Interference) reduction. The peak of unnecessary radiation noise (EMI) can be attenuated by making the oscillation frequency slightly modulate periodically with the internal modulator. It corresponds to both of the center spread which modulates input frequency as Middle Centered and down spread which modulates so as not to exceed input frequency.

### Features

- Input frequency : 16.6 MHz to 80 MHz
- Output frequency: 16.6 MHz to 80 MHz (One time input frequency)
- Modulation rate can select from  $\pm 0.5\%$ ,  $\pm 1.0\%$ ,  $\pm 1.5\%$  or  $- 1.0\%$ ,  $- 2.0\%$ ,  $- 3.0\%$ . (For center spread / down spread.)
- Equipped with crystal oscillation circuit: Range of oscillation 16.6 MHz to 48 MHz
- The external clock can be input: 16.6 MHz to 80 MHz
- Modulation clock output duty : 40% to 60%
- Modulation clock cycle-cycle jitter : Less than 100 ps
- Low current consumption by CMOS process : 5.0 mA (24 MHz : Typ-sample, no load)
- Power supply voltage : 3.3 V  $\pm$  0.3 V
- Operating temperature :  $- 40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$
- Package : SOP 8-pin

**Contents**

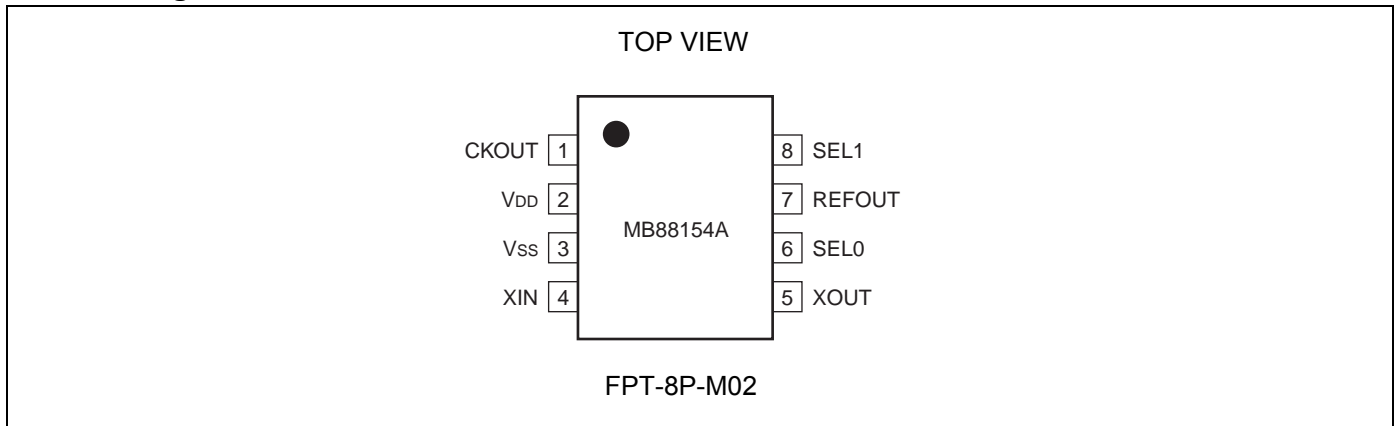
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## 1. Product Lineup

MB88154A has two kinds of input frequency, and three kinds of modulation type (center/down spread), total six line-ups.

Product	Input/Output frequency	Modulation type
MB88154A-101	50 MHz to 80 MHz	Down spread
MB88154A-102	33 MHz to 67 MHz	
MB88154A-103	16.6 MHz to 40 MHz	
MB88154A-111	50 MHz to 80 MHz	Center spread
MB88154A-112	33 MHz to 67 MHz	
MB88154A-113	16.6 MHz to 40 MHz	

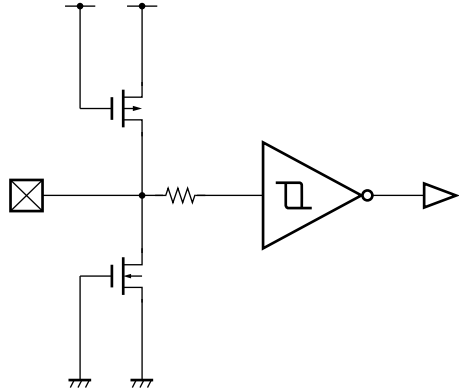
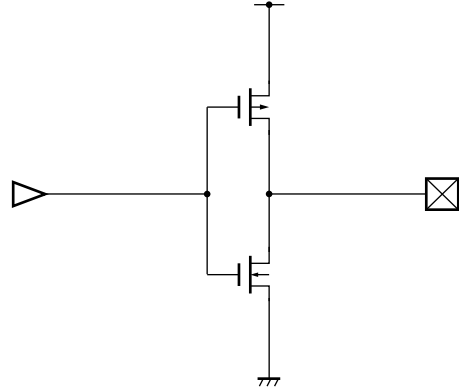
## 2. Pin Assignment



## 3. Pin Description

Pin name	I/O	Pin no.	Description
CKOUT	O	1	Modulated clock output pin
V <sub>DD</sub>	—	2	Power supply voltage pin
V <sub>SS</sub>	—	3	GND pin
XIN	I	4	Crystal resonator connection pin/clock input pin
XOUT	O	5	Crystal resonator connection pin
SEL0	I	6	Modulation rate setting pin
REFOUT	O	7	Non-modulated clock output pin
SEL1	I	8	Modulation rate setting pin

#### 4. I/O Circuit Type

Pin	Circuit type	Remarks
SEL0 SEL1		CMOS hysteresis input
CKOUT REFOUT		<ul style="list-style-type: none"> <li>■ CMOS output</li> <li>■ <math>I_{OL} = 3 \text{ mA}</math></li> </ul>

Note : For XIN and XOUT pins, refer to “[Oscillation Circuit](#)”

## **5. Handling Devices**

### **5.1 Preventing Latch-up**

A latch-up can occur if, on this device, (a) a voltage higher than  $V_{DD}$  or a voltage lower than  $V_{SS}$  is applied to an input or output pin or (b) a voltage higher than the rating is applied between  $V_{DD}$  pin and  $V_{SS}$  pin. The latch-up, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use this device, be very careful not to exceed the maximum rating.

### **5.2 Handling unused pins**

Do not leave an unused input pin open, since it may cause a malfunction. Handle by, using a pull-up or pull-down resistor.

Unused output pin should be opened.

### **5.3 The attention when the external clock is used**

Input the clock to XIN pin, and XOUT pin should be opened when you use the external clock.

Please pay attention so that an overshoot and an undershoot do not occur to an input clock of XIN pin.

### **5.4 Power supply pins**

Please design connecting the power supply pin of this device by as low impedance as possible from the current supply source.

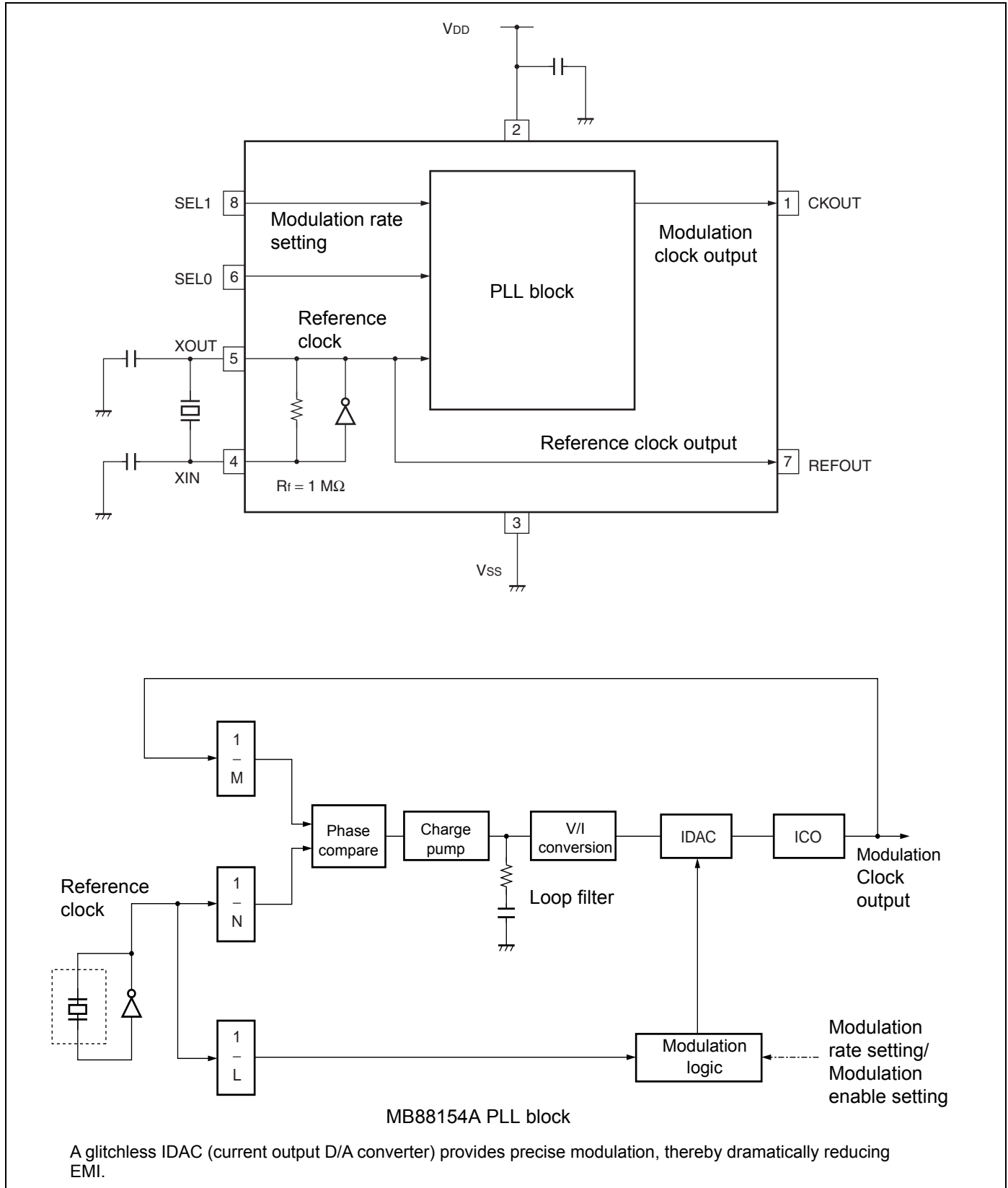
We recommend connecting electrolytic capacitor (about 10  $\mu\text{F}$ ) and the ceramic capacitor (about 0.01  $\mu\text{F}$ ) in parallel between  $V_{SS}$  pin and  $V_{DD}$  pin near the device, as a bypass capacitor.

### **5.5 Oscillation circuit**

Noise near the XIN and XOUT pins may cause the device to malfunction. Design printed circuit boards so that electric wiring of XIN or XOUT pin and the resonator do not intersect other wiring.

Design the printed circuit board that surrounds the XIN and XOUT pins with ground.

## 6. Block Diagram



## 7. Pin Setting

### SEL 0, SEL 1 Modulation rate setting

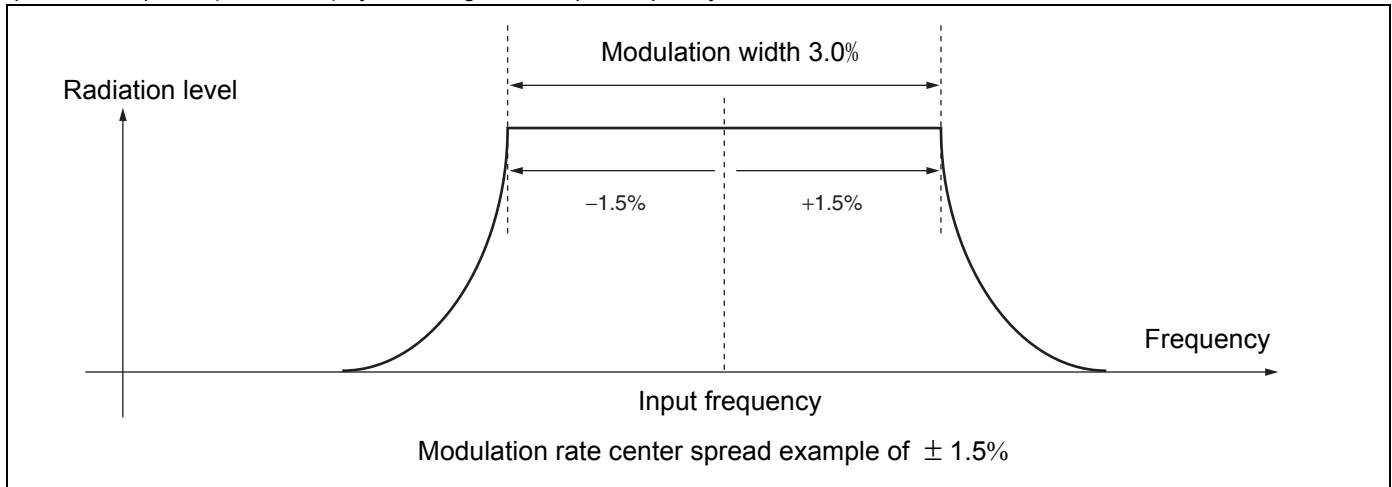
SEL1	SEL0	Modulation rate	
		MB88154A-101, MB88154A-102, MB88154A-103	MB88154A-111, MB88154A-112, MB88154A-113
		Down spread	Center spread
L	L	- 1.0%	± 0.5%
L	H	- 2.0%	± 1.0%
H	L	- 3.0%	± 1.5%
H	H	No spread	No spread

Notes:

- The modulation rate can be changed at the level of the pin. Spectrum does not spread when “H” level is set to SEL0 and SEL1 pins. The clock with low jitter can be obtained.
- When changing the modulation rate setting, the stabilization wait time for the modulation clock is required. The stabilization wait time for the modulation clock take the maximum value of “[Electrical Characteristics AC Characteristics Lock-Up time](#)”.

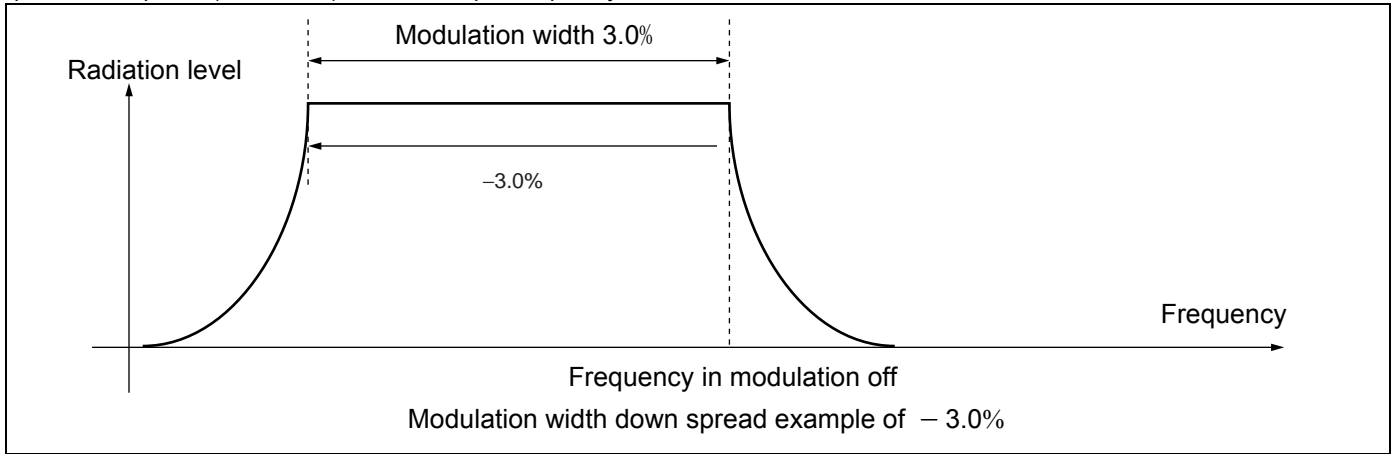
### Center spread

Spectrum is spread (modulated) by centering on the input frequency.



**Down spread**

Spectrum is spread (modulated) below the input frequency.



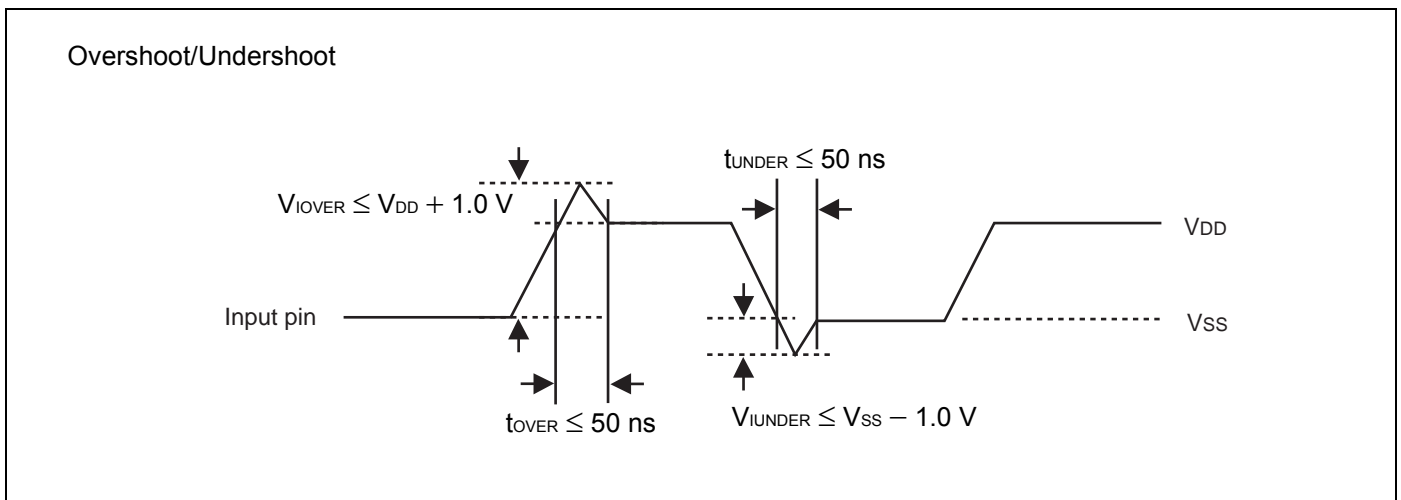


## 8. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit
		Min	Max	
Power supply voltage*	$V_{DD}$	- 0.5	+ 4.0	V
Input voltage*	$V_I$	$V_{SS} - 0.5$	$V_{DD} + 0.5$	V
Output voltage*	$V_O$	$V_{SS} - 0.5$	$V_{DD} + 0.5$	V
Storage temperature	$T_{ST}$	- 55	+ 125	°C
Operation junction temperature	$T_J$	- 40	+ 125	°C
Output current	$I_O$	- 14	+ 14	mA
Overshoot	$V_{I\text{OVER}}$	—	$V_{DD} + 1.0$ ( $t_{\text{OVER}} \leq 50 \text{ ns}$ )	V
Undershoot	$V_{I\text{UNDER}}$	$V_{SS} - 1.0$ ( $t_{\text{UNDER}} \leq 50 \text{ ns}$ )	—	V

\* : The parameter is based on  $V_{SS} = 0.0 \text{ V}$ .

**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

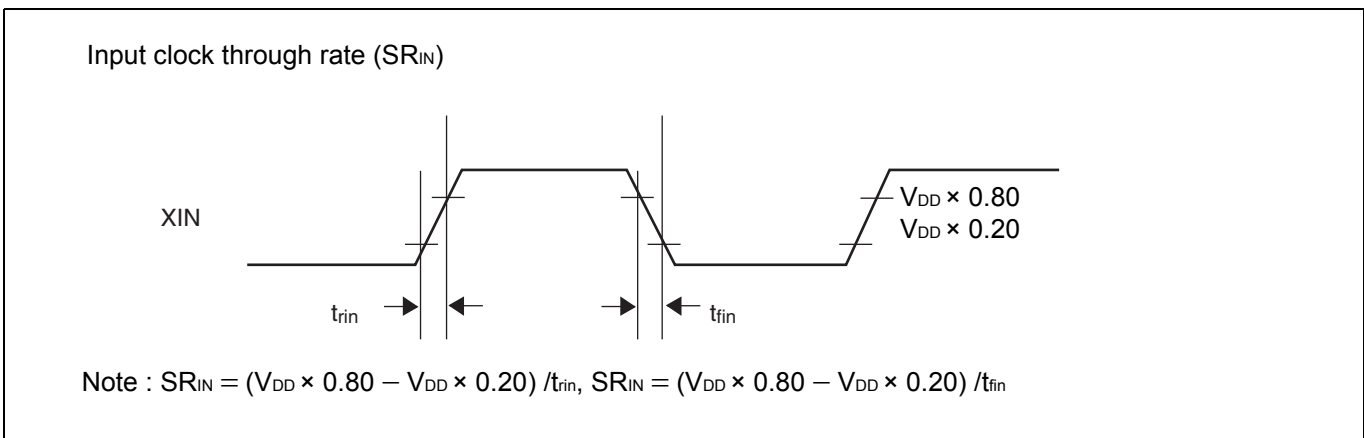
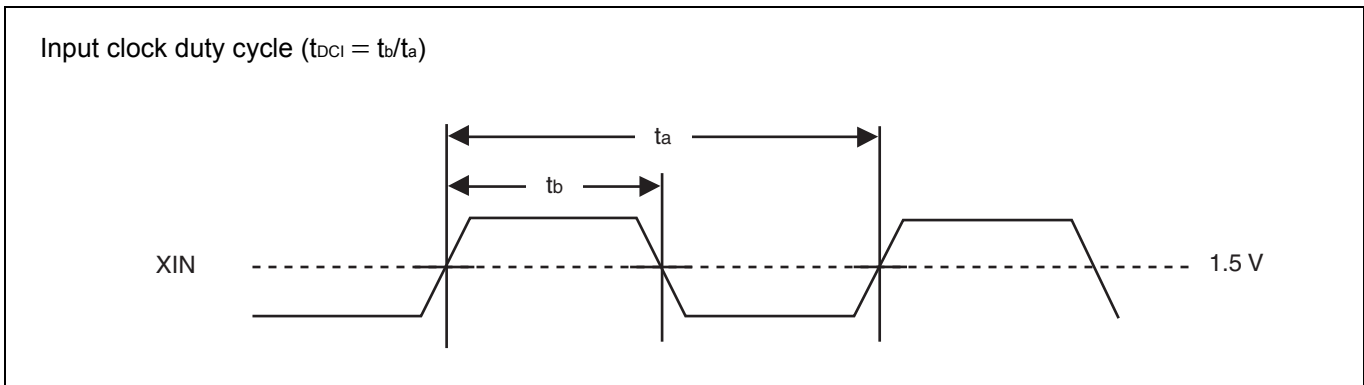


## 9. Recommended Operating Conditions

(V<sub>SS</sub> = 0.0 V)

Parameter	Symbol	Pin	Conditions	Value			Unit
				Min	Typ	Max	
Power supply voltage	V <sub>DD</sub>	V <sub>DD</sub>	—	3.0	3.3	3.6	V
“H” level input voltage	V <sub>IH</sub>	XIN, SEL0, SEL1	—	V <sub>DD</sub> × 0.80	—	V <sub>DD</sub> + 0.3	V
“L” level input voltage	V <sub>IL</sub>		—	V <sub>SS</sub>	—	V <sub>DD</sub> × 0.20	V
Input clock duty cycle	t <sub>DCI</sub>	XIN	16.6 MHz to 80 MHz	40	50	60	%
Input clock through rate	SR <sub>IN</sub>	XIN	Input frequency 40 MHz to 80 MHz	0.0475 × f <sub>in</sub> – 1.75	—	—	V/ns
Operating temperature	T <sub>a</sub>	—	—	– 40	—	+ 85	°C

**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges. Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.



## 10. Electrical Characteristics

### ■ DC Characteristics

( $T_a = -40\text{ }^\circ\text{C}$  to  $+85\text{ }^\circ\text{C}$ ,  $V_{DD} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = 0.0\text{ V}$ )

Parameter	Symbol	Pin	Conditions	Value			Unit
				Min	Typ	Max	
Power supply current	$I_{CC}$	$V_{DD}$	no load capacitance at 24 MHz output	—	5.0	7.0	mA
Output voltage	$V_{OH}$	CKOUT, REFOUT	“H” level output $I_{OH} = -3\text{ mA}$	$V_{DD} - 0.5$	—	$V_{DD}$	V
	$V_{OL}$		“L” level output $I_{OL} = 3\text{ mA}$	$V_{SS}$	—	0.4	V
Output impedance	$Z_o$	CKOUT, REFOUT	16.6 MHz to 80 MHz	—	70	—	$\Omega$
Input capacitance	$C_{IN}$	XIN, SEL0, SEL1	$T_a = +25\text{ }^\circ\text{C}$ , $V_{DD} = V_I = 0.0\text{ V}$ , $f = 1\text{ MHz}$	—	—	16	pF

**■ AC Characteristics**

 (Ta = -40 °C to +85 °C, V<sub>DD</sub> = 3.3 V ± 0.3 V, V<sub>SS</sub> = 0.0 V)

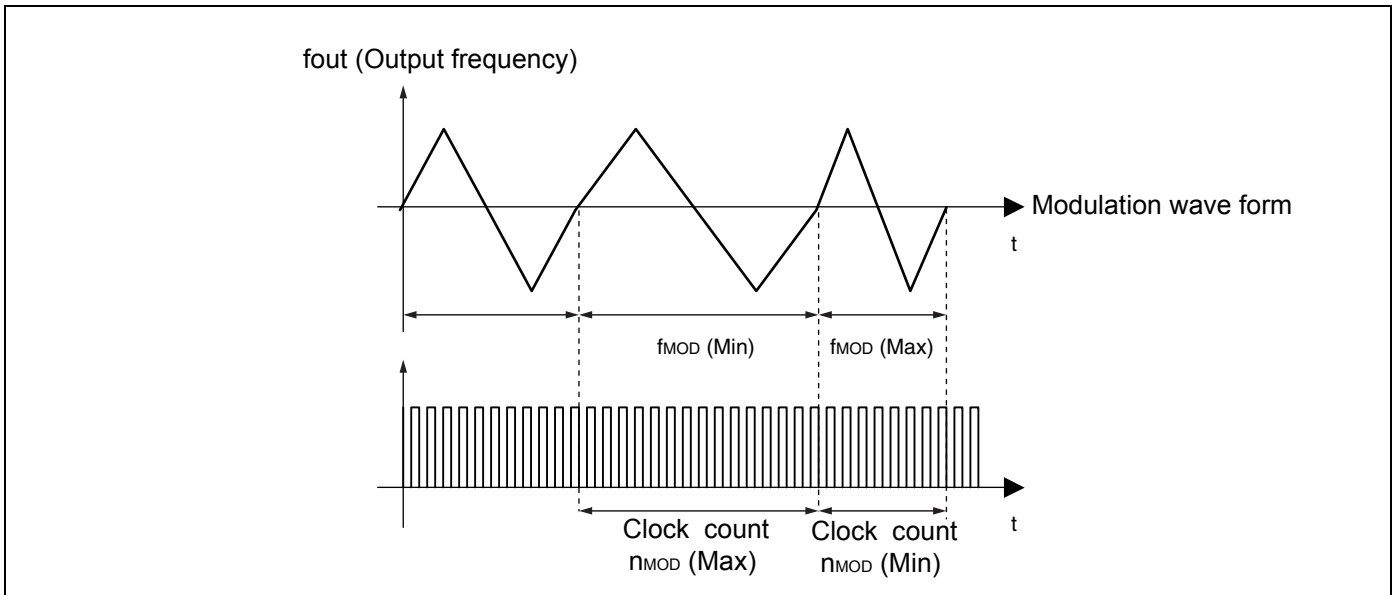
Parameter	Symbol	Pin	Conditions	Value			Unit
				Min	Typ	Max	
Oscillation frequency	f <sub>x</sub>	XIN, XOUT	Fundamental oscillation	16.6	—	40	MHz
			3rd over-tone oscillation	40	—	48	
Input frequency	f <sub>in</sub>	XIN	MB88154A-103/113	16.6	—	40	MHz
			MB88154A-102/112	33	—	67	
			MB88154A-101/111	50	—	80	
Output frequency	f <sub>OUT</sub>	CKOUT, REFOUT	MB88154A-103/113	16.6	—	40	MHz
			MB88154A-102/112	33	—	67	
			MB88154A-101/111	50	—	80	
Output slew rate	SR	CKOUT, REFOUT	0.4 V to 2.4 V load capacitance 15 pF	0.3	—	2.0	V/ns
Output clock duty cycle	t <sub>DCC</sub>	CKOUT	1.5 V	40	—	60	%
	t <sub>DCR</sub>	REFOUT	1.5 V	t <sub>DCI</sub> - 10*	—	t <sub>DCI</sub> + 10*	%
Modulation frequency (Number of input clocks per modulation)	f <sub>MOD</sub> (n <sub>MOD</sub> )	CKOUT	MB88154A-103/113	f <sub>in</sub> /2640 (2640)	f <sub>in</sub> /2280 (2280)	f <sub>in</sub> /1920 (1920)	kHz (clks)
			MB88154A-102/112	f <sub>in</sub> /4400 (4400)	f <sub>in</sub> /3800 (3800)	f <sub>in</sub> /3200 (3200)	
			MB88154A-101/111	f <sub>in</sub> /5280 (5280)	f <sub>in</sub> /4560 (4560)	f <sub>in</sub> /3840 (3840)	
Lock-Up time	t <sub>LK</sub>	CKOUT	—	—	2	5	ms
Cycle-cycle jitter	t <sub>JC</sub>	CKOUT	No load capacitance, Ta = +25 °C, V <sub>DD</sub> = 3.3 V	—	—	100	ps-rms

\* : Duty of the REFOUT output is guaranteed only for the following A and B because it depends on t<sub>DCI</sub> of input clock duty.

A. Resonator : When resonator is connected with XIN and XOUT and oscillates normally.

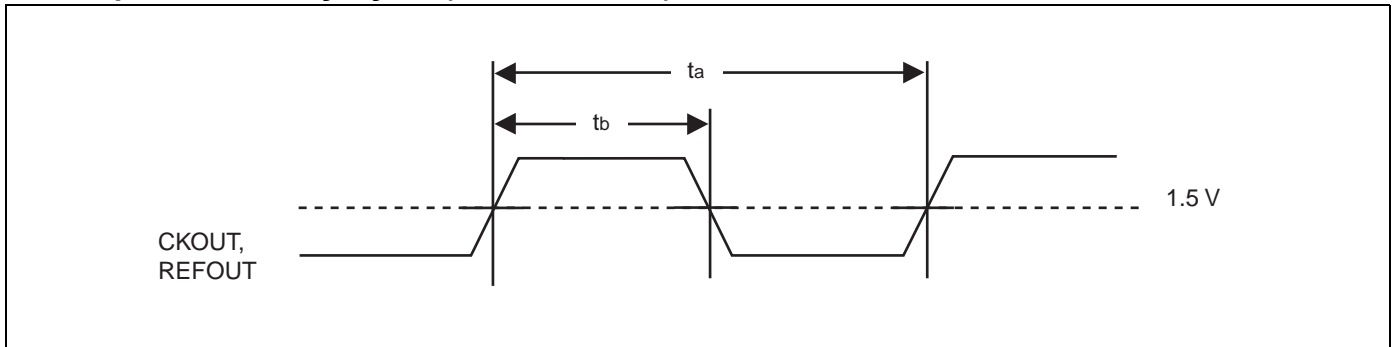
B. External clock input : The input level is Full - swing (V<sub>SS</sub> - V<sub>DD</sub>).

<Definition of modulation frequency and number of input clocks per modulation>

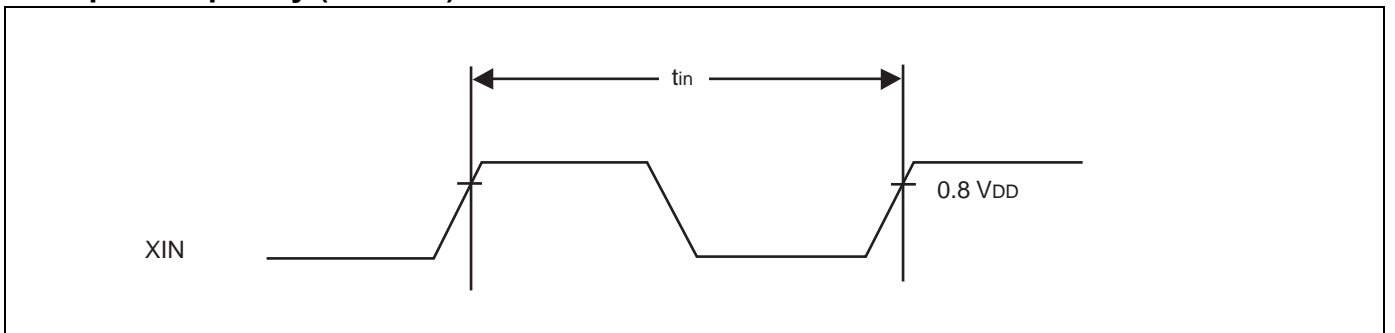


MB88154A contains the modulation period to realize the efficient EMI reduction. The modulation period  $f_{MOD}$  depends on the input frequency and changes between  $f_{MOD} (Min)$  and  $f_{MOD} (Max)$ . Furthermore, the average value of  $f_{MOD}$  equals the typical value of the electrical characteristics.

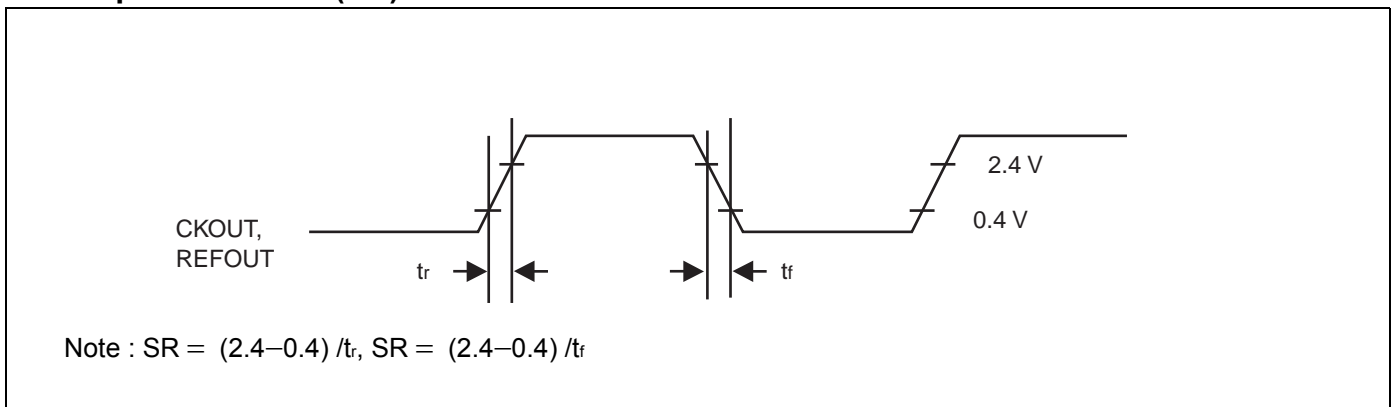
**11. Output Clock Duty Cycle ( $t_{DCC}$ ,  $t_{DCR} = t_b/t_a$ )**



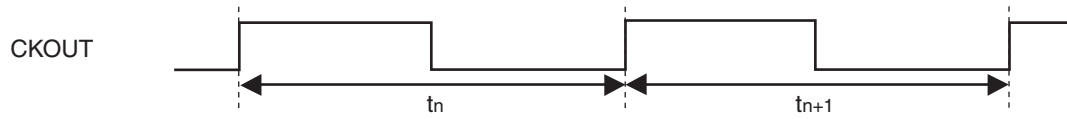
**12. Input Frequency ( $f_{in} = 1/t_{in}$ )**



**13. Output Slew Rate (SR)**



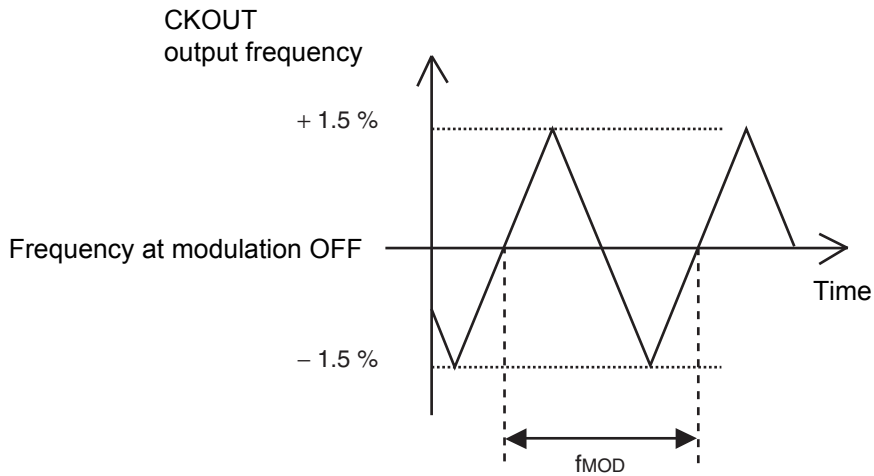
#### 14. Cycle-cycle Jitter ( $t_{JC} = |t_n - t_{n+1}|$ )



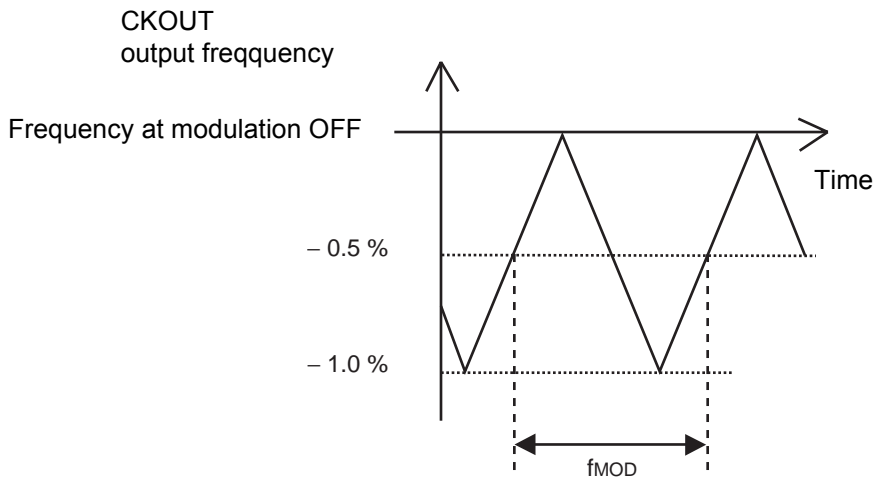
Note : Cycle-cycle jitter is defined the difference between a certain cycle and immediately after (or, immediately before) .

### 15. Modulation Waveform

- $\pm 1.5\%$  modulation rate, Example of center spread

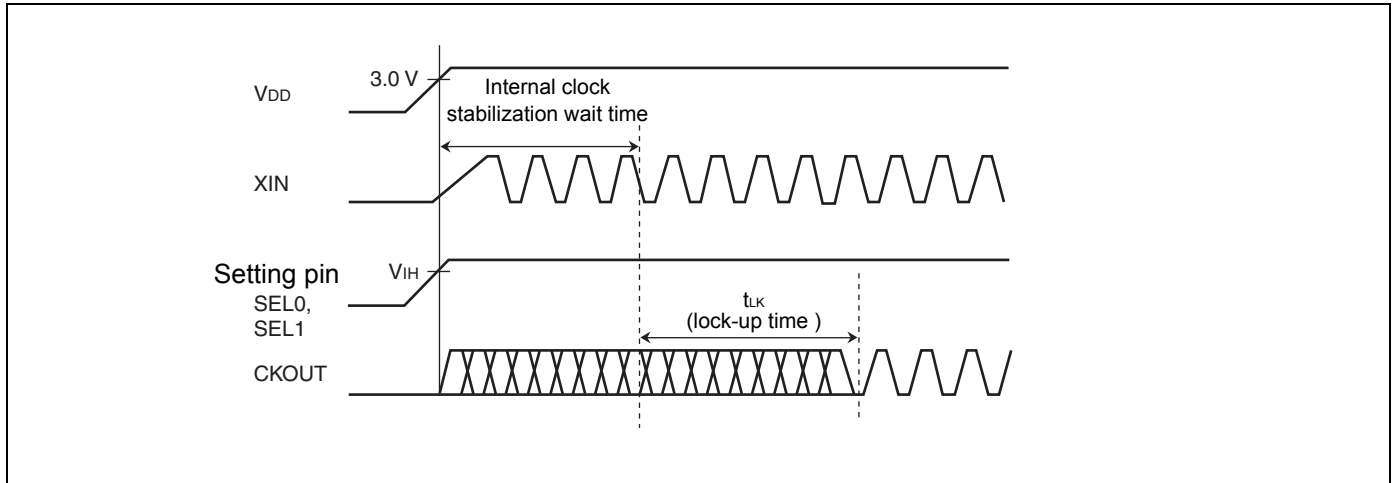


- $-1.0\%$  modulation rate, Example of down spread





## 16. Lock-up Time

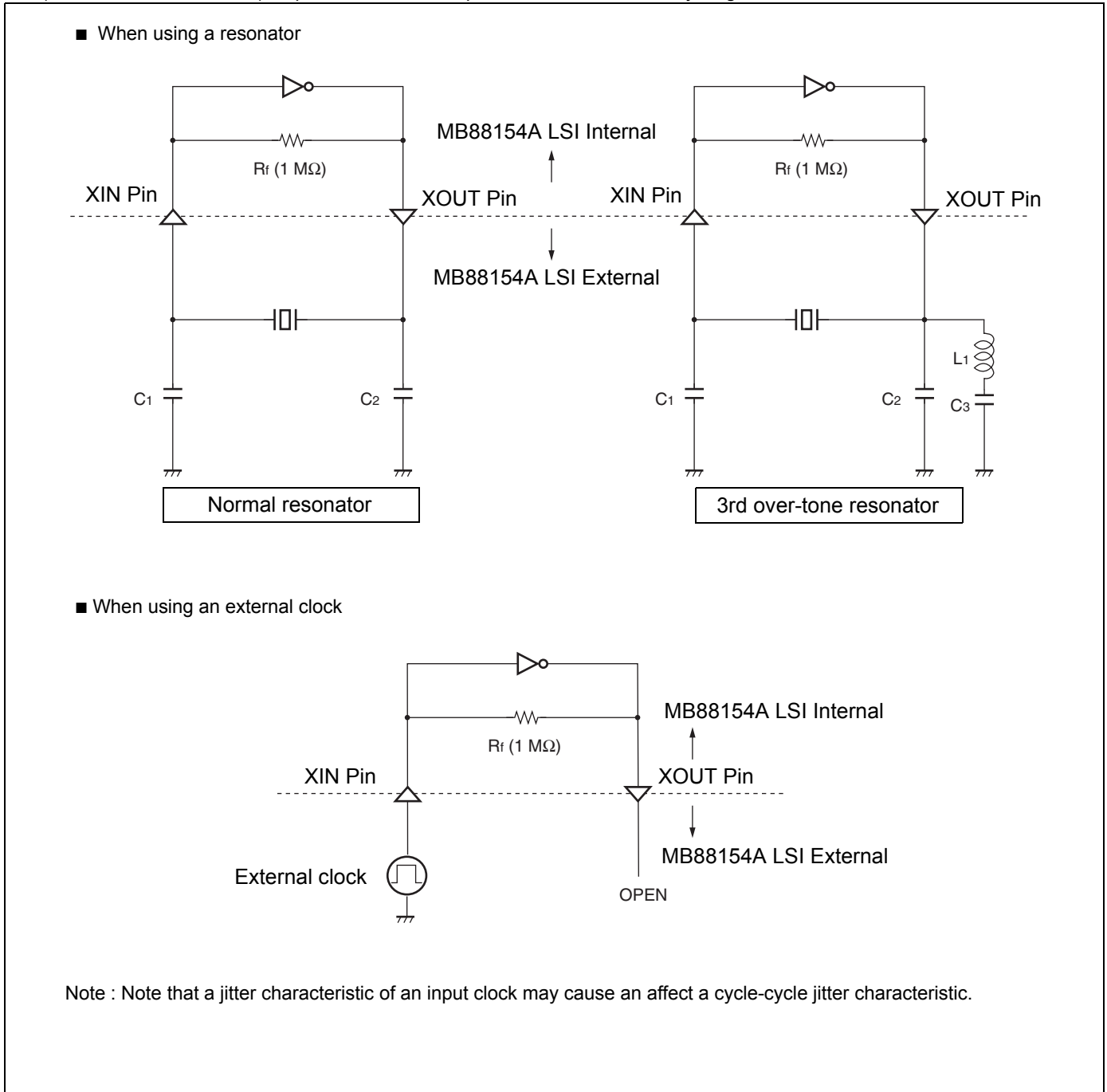


If the setting pin is fixed at the "H" or "L" level, the maximum time after the power is turned on until the set clock signal is output from CKOUT pin is (the stabilization wait time of input clock to XIN pin) + (the lock-up time "t<sub>LK</sub>"). For the input clock stabilization time, check the characteristics of the resonator or oscillator used.

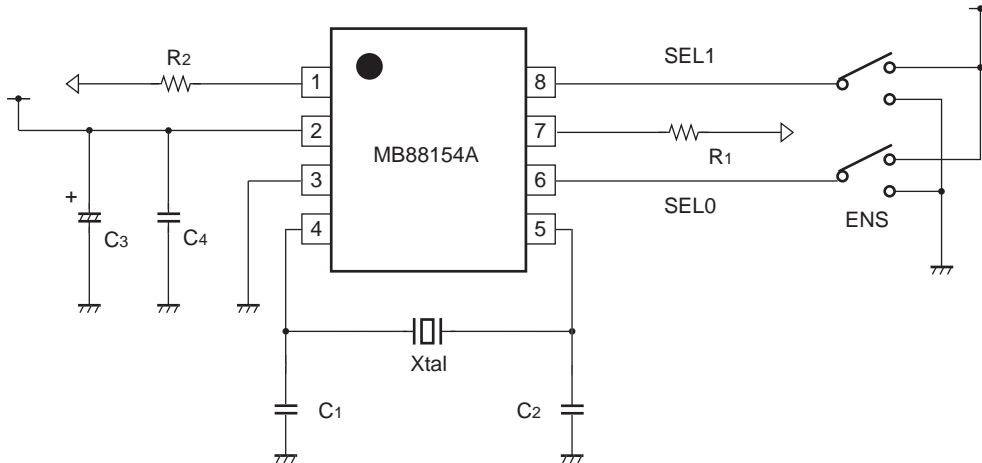
Note : When the pin setting is changed, the CKOUT pin output clock stabilization time is required. Until the output clock signal becomes stable, the output frequency, output clock duty cycle, modulation period, and cycle-cycle jitter cannot be guaranteed. It is therefore advisable to perform processing such as cancelling a reset of the device at the succeeding stage after the lock-up time.

### 17. Oscillation Circuit

The left side of figures below shows the connection example about general resonator. The oscillation circuit has the built-in feedback resistance ( $R_f$ ). The value of capacity ( $C_1$  and  $C_2$ ) is required adjusting to the most suitable value of an individual resonator. The right side of figures below shows the example of connecting for the 3rd over-tone resonator. The value of capacity ( $C_1$ ,  $C_2$  and  $C_3$ ) and inductance ( $L_1$ ) is needed adjusting to the most suitable value of an individual resonator. The most suitable value is different by individual resonator. Please refer to the resonator manufacturer which use for the most suitable value. When an external clock is used (the resonator is not used), input the clock to XIN pin and do not connect anything with XOUT.



## 18. Interconnection Circuit Example



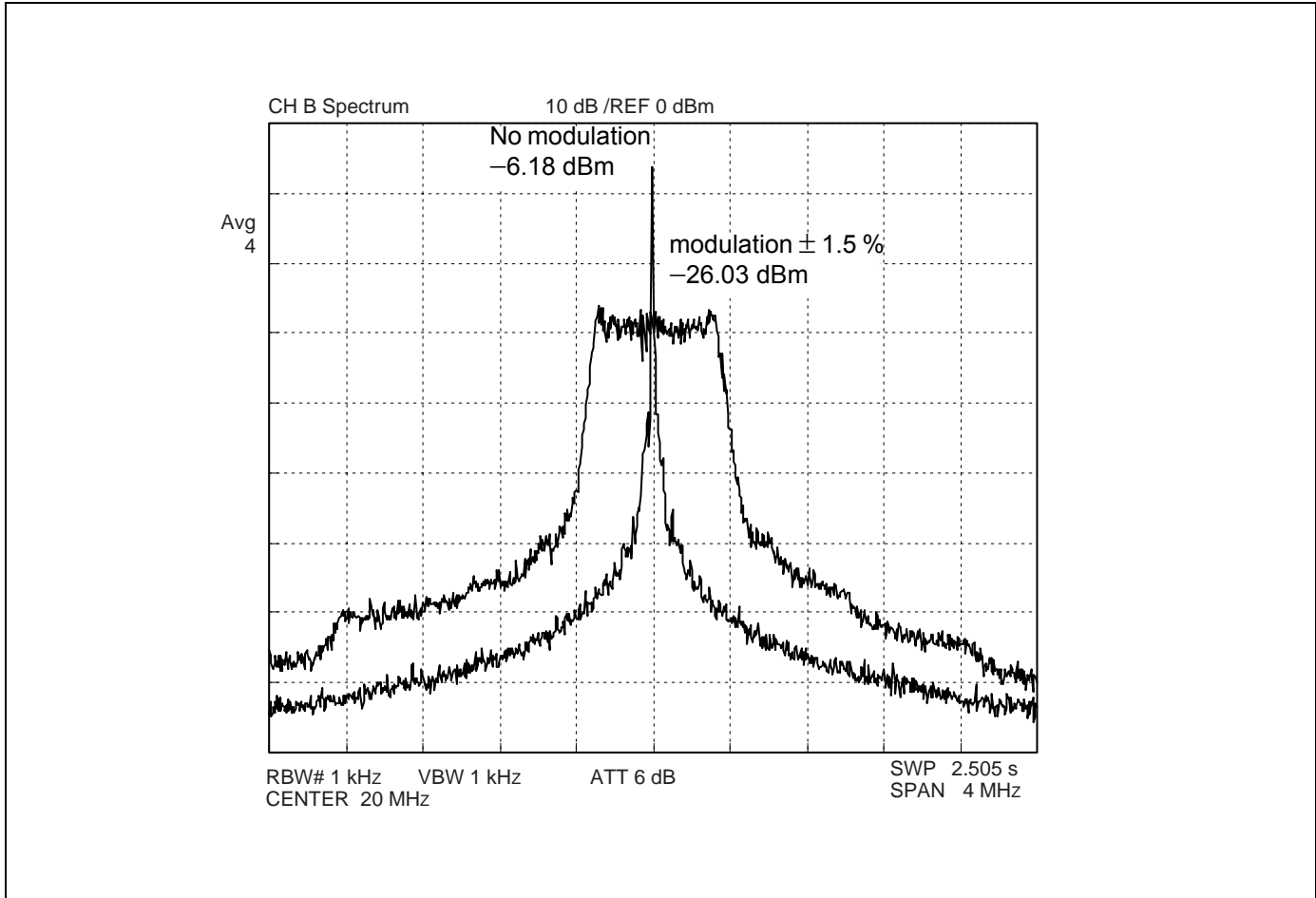
- C<sub>1</sub>, C<sub>2</sub> : Oscillation stabilization capacitance (refer to “ [Oscillation Circuit](#)”.)
- C<sub>3</sub> : Capacitor of 10 μF or higher
- C<sub>4</sub> : Capacitor about 0.01 μF (connect a capacitor of good high frequency property (ex. laminated ceramic capacitor) to close to this device.)
- R<sub>1</sub>, R<sub>2</sub> : Impedance matching resistor for board pattern

### 19. Example Characteristics

The condition of the examples of the characteristic is shown as follows: Input frequency = 20 MHz (Output frequency = 20 MHz : Using MB88154A-113), Power - supply voltage = 3.3 V, None load capacity.

Modulation rate =  $\pm 1.5\%$  (center spread)

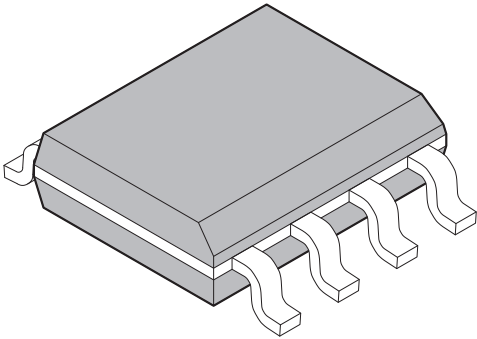
Spectrum analyzer HP4396B is connected with CKOUT. The result of the measurement with RBW = 1 kHz (ATT use for - 6dB).

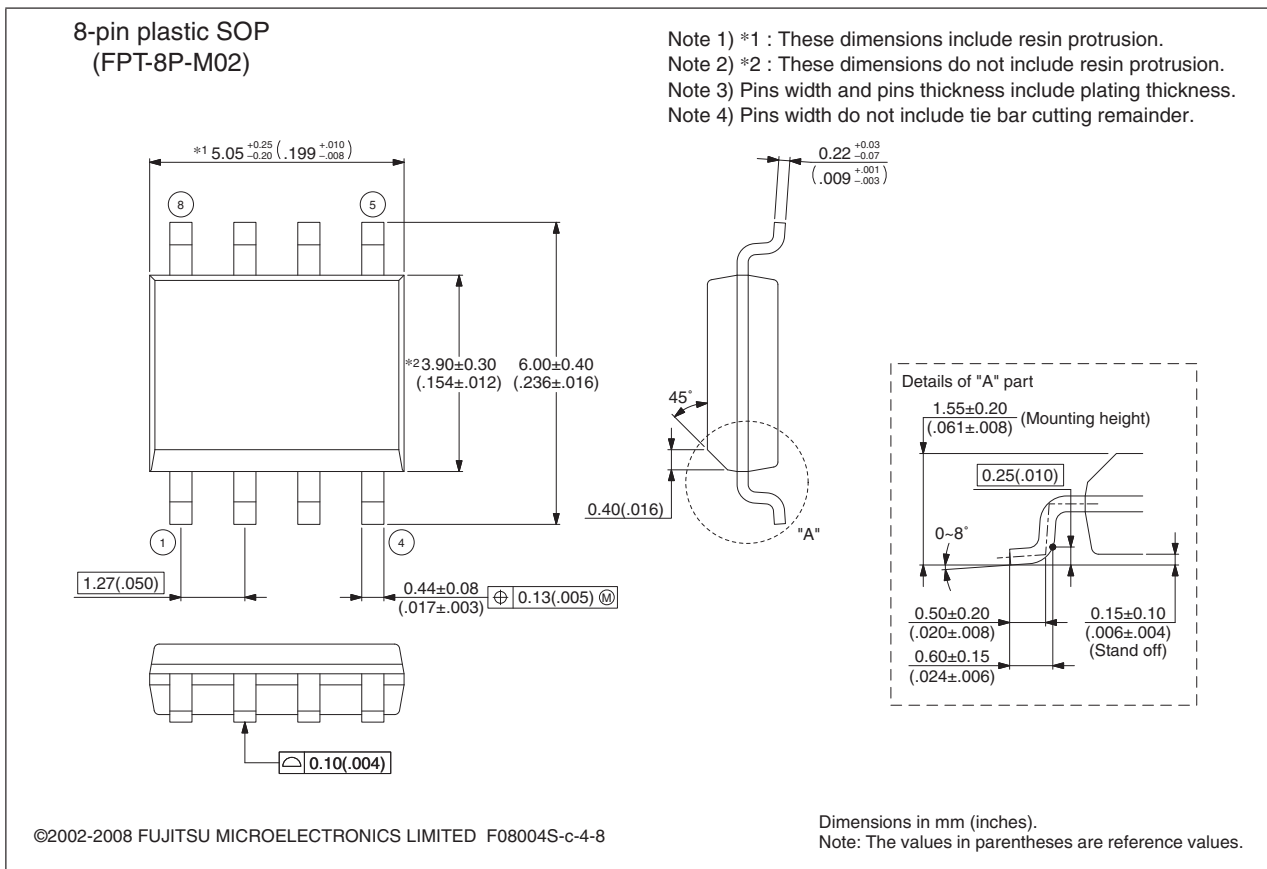


**20. Ordering Information**

Part number	Input/Output frequency	Modulation type	Package	Remarks
MB88154APNF-G-101-JNE1 MB88154APNF-G-102-JNE1 MB88154APNF-G-103-JNE1 MB88154APNF-G-111-JNE1 MB88154APNF-G-112-JNE1 MB88154APNF-G-113-JNE1	50 MHz to 80 MHz 33 MHz to 67 MHz 16.6 MHz to 40 MHz 50 MHz to 80 MHz 33 MHz to 67 MHz 16.6 MHz to 40 MHz	Down Down Down Center Center Center	8-pin plastic SOP (FPT-8P-M02)	
MB88154APNF-G-101-JNEFE1 MB88154APNF-G-102-JNEFE1 MB88154APNF-G-103-JNEFE1 MB88154APNF-G-111-JNEFE1 MB88154APNF-G-112-JNEFE1 MB88154APNF-G-113-JNEFE1	50 MHz to 80 MHz 33 MHz to 67 MHz 16.6 MHz to 40 MHz 50 MHz to 80 MHz 33 MHz to 67 MHz 16.6 MHz to 40 MHz	Down Down Down Center Center Center	8-pin plastic SOP (FPT-8P-M02)	Emboss taping (EF type)
MB88154APNF-G-101-JNERE1 MB88154APNF-G-102-JNERE1 MB88154APNF-G-103-JNERE1 MB88154APNF-G-111-JNERE1 MB88154APNF-G-112-JNERE1 MB88154APNF-G-113-JNERE1	50 MHz to 80 MHz 33 MHz to 67 MHz 16.6 MHz to 40 MHz 50 MHz to 80 MHz 33 MHz to 67 MHz 16.6 MHz to 40 MHz	Down Down Down Center Center Center	8-pin plastic SOP (FPT-8P-M02)	Emboss taping (ER type)

**21. Package Dimension**

<p style="text-align: center;">8-pin plastic SOP</p>  <p style="text-align: center;">(FPT-8P-M02)</p>	Lead pitch	1.27 mm
	Package width × package length	3.9 × 5.05 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.75 mm MAX
	Weight	0.06 g



## Document History

Spansion Publication Number: DS04-29129-2E

Document Title: MB88154A Spread Spectrum Clock Generator Document Number: 002-08252				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	–	TAOA	06/29/2009	Initial Release
*A	5563140	TAOA	12/22/2016	Updated to Cypress Template

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